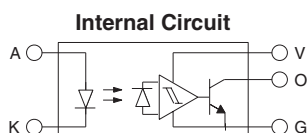
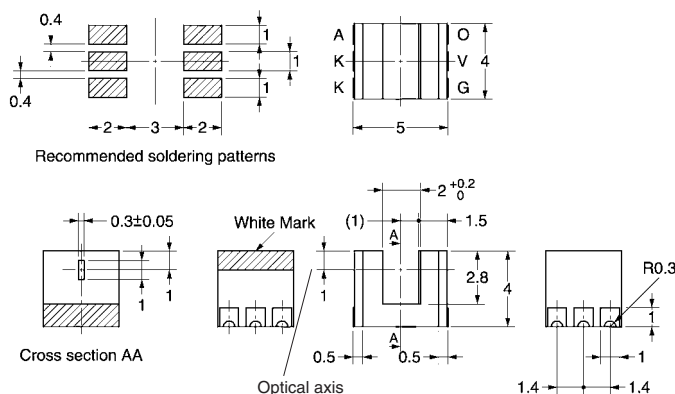


Photomicrosensor (Transmissive) EE-SX4134

⚠ Be sure to read *Precautions* on page 25.

■ Dimensions

Note: All units are in millimeters unless otherwise indicated.



Unless otherwise specified, the tolerances are ± 0.15 mm.

Terminal No.	Name
A	Anode
K	Cathode
V	Supply voltage (V _{CC})
O	Output (OUT)
G	Ground (GND)

■ Features

- Ultra-compact model.
- Photo IC output model.
- Operates at a V_{CC} of 2.2 to 7 V.
- PCB surface mounting type.

■ Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rated value
Emitter	Forward current	I _F
	Reverse voltage	V _R
Detector	Supply voltage	V _{CC}
	Output voltage	V _{OUT}
	Output current	I _{OUT}
	Permissible output dissipation	P _{OUT}
Ambient temperature	Operating	T _{opr}
	Storage	T _{stg}
	Reflow soldering	T _{sol}
	Manual soldering	T _{sol}

Note: 1. Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

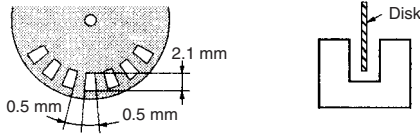
2. Complete soldering within 10 seconds for reflow soldering and within 3 seconds for manual soldering.

■ Electrical and Optical Characteristics (Ta = 25°C)

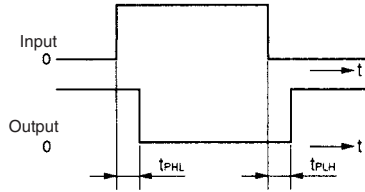
Item	Symbol	Value	Condition
Emitter	Forward voltage	V _F	1.2 V typ., 1.4 V max.
	Reverse current	I _R	0.01 μ A typ., 10 μ A max.
	Peak emission wave-length	λ_p	940 nm typ.
Detector	Power supply voltage	V _{CC}	2.2 V min., 7 V max.
	Low-level output voltage	V _{OL}	0.12 V typ., 0.4 V max.
	High-level output current	I _{OH}	10 μ A max.
	Current consumption	I _{CC}	2.8 mA typ., 4 mA max.
	Peak spectral sensitivity wavelength	λ_p	870 nm typ.
LED current when output is ON		I _{FT}	2.0 mA typ., 3.5 mA max.
Hysteresis		ΔH	21% typ.
Response frequency		f	3 kHz min.
Response delay time		t _{PHL}	7 μ s typ.
Response delay time		t _{PLH}	18 μ s typ.

Note: 1. Hysteresis denotes the difference in forward LED current value, expressed in percentage, calculated from the respective forward LED currents when the photo IC is turned from ON to OFF and when the photo IC is turned from OFF to ON.

2. The value of the response frequency is measured by rotating the disk as shown below.

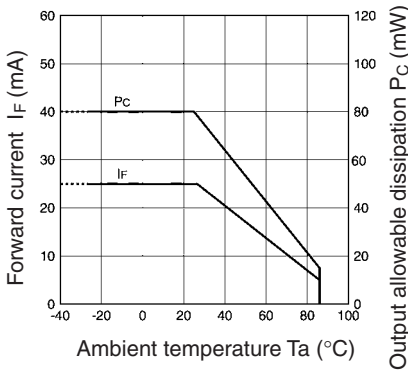


3. The following illustrations show the definition of response delay time.

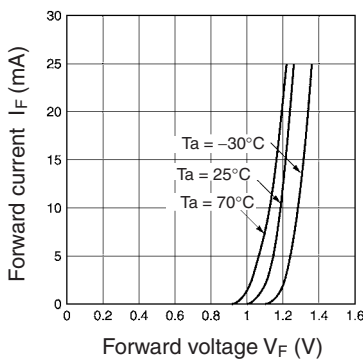


Engineering Data

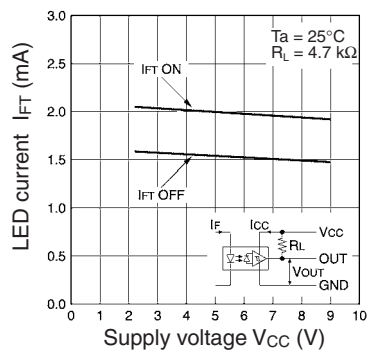
Forward Current vs. Collector Dissipation Temperature Rating



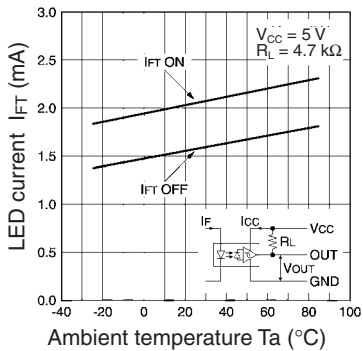
Forward Current vs. Forward Voltage Characteristics (Typical)



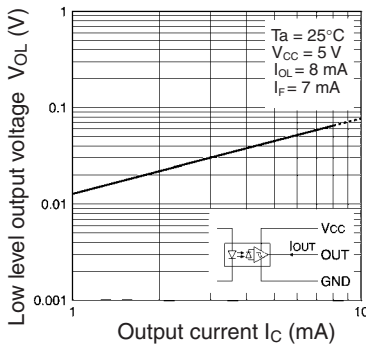
LED Current vs. Supply Voltage (Typical)



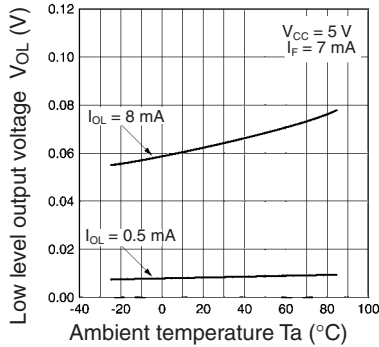
LED Current vs. Ambient Temperature Characteristics (Typical)



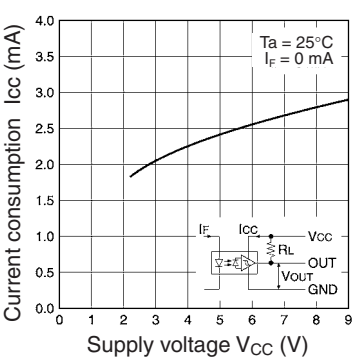
Low-level Output Voltage vs. Output Current (Typical)



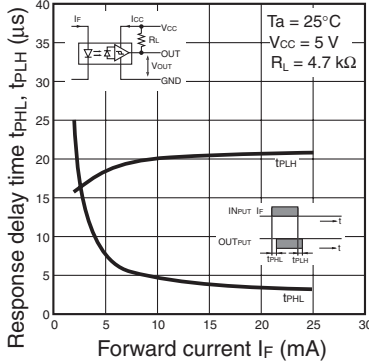
Low-level Output Voltage vs. Ambient Temperature Characteristics (Typical)



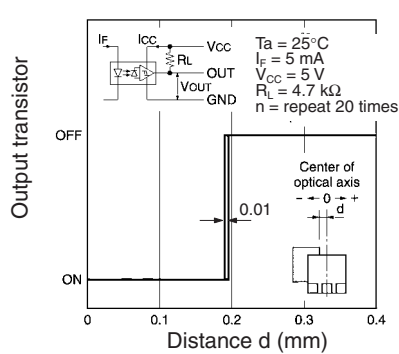
Current Consumption vs. Supply Voltage (Typical)



Response Delay Time vs. Forward Current (Typical)



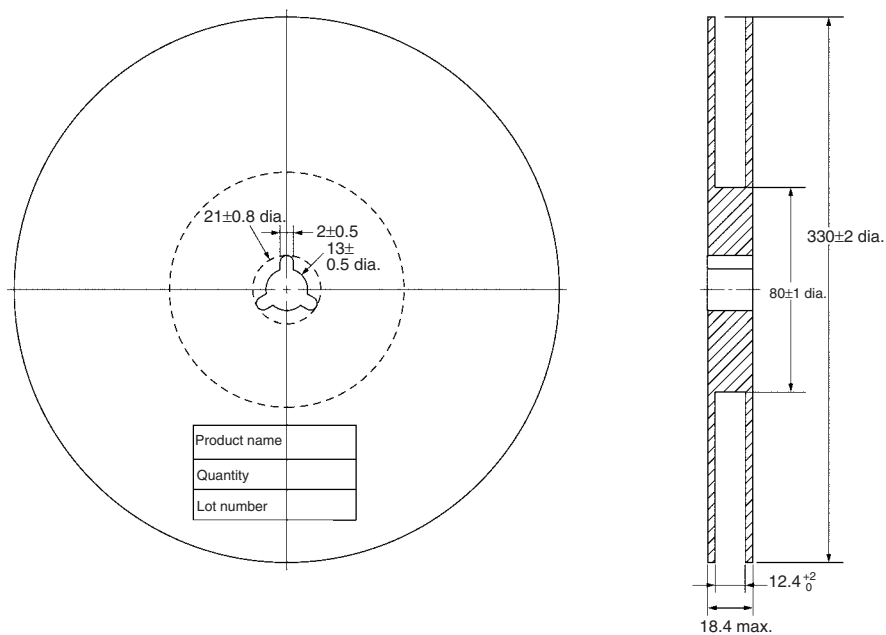
Repeat Sensing Position Characteristics (Typical)



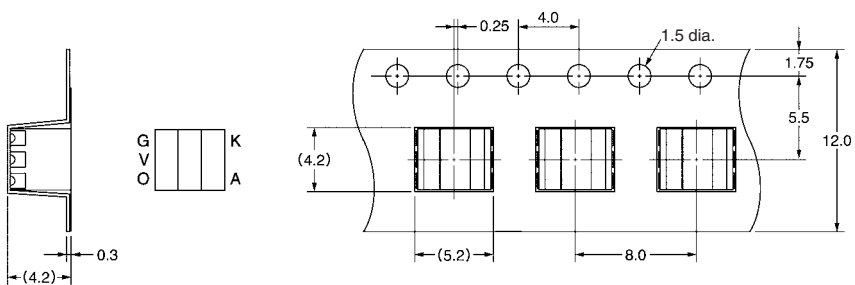
Unit: mm (inch)

■ Tape and Reel

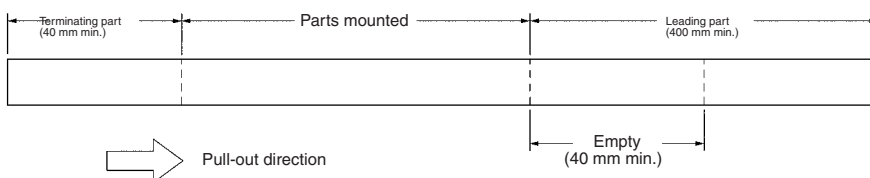
Reel



Tape



Tape configuration



Tape quantity

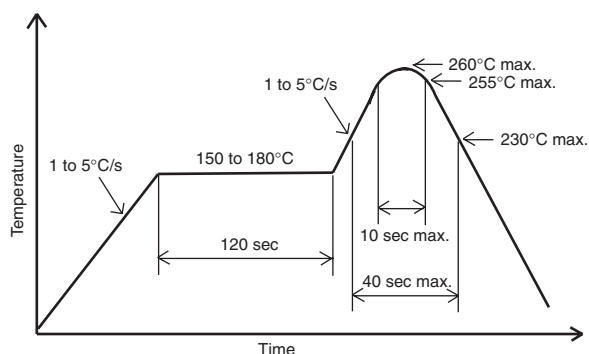
2,000 pcs./reel

Precautions

■ Soldering Information

Reflow soldering

- The following soldering paste is recommended:
Melting temperature: 216 to 220°C
Composition: Sn 3.5 Ag 0.75 Cu
- The recommended thickness of the metal mask for screen printing is between 0.2 and 0.25 mm.
- Set the reflow oven so that the temperature profile shown in the following chart is obtained for the upper surface of the product being soldered.



Manual soldering

- Use "Sn 60" (60% tin and 40% lead) or solder with silver content.
- Use a soldering iron of less than 25 W, and keep the temperature of the iron tip at 300°C or below.
- Solder each point for a maximum of three seconds.
- After soldering, allow the product to return to room temperature before handling it.

Storage

To protect the product from the effects of humidity until the package is opened, dry-box storage is recommended. If this is not possible, store the product under the following conditions:

Temperature: 10 to 30°C

Humidity: 60% max.

The product is packed in a humidity-proof envelope. Reflow soldering must be done within 48 hours after opening the envelope, during which time the product must be stored under 30°C at 80% maximum humidity.

If it is necessary to store the product after opening the envelope, use dry-box storage or reseal the envelope.

Baking

If a product has remained packed in a humidity-proof envelope for six months or more, or if more than 48 hours have lapsed since the envelope was opened, bake the product under the following conditions before use:

Reel: 60°C for 24 hours or more

Bulk: 80°C for 4 hours or more



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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